

## Radiation Hardened Quad-Channel Dual-Input Arbiter

with cold sparing

### 1 GENERAL DESCRIPTION

The AP54RHC486 is a radiation-hardened by design Quad-Channel Dual-Input Arbiter that is ideally suited for space, medical imaging and other applications demanding radiation tolerance and high reliability. It is fabricated in a 180 nm CMOS process utilizing proprietary radiation-hardening techniques, delivering high resiliency to single-event effects (SEE) and to a total ionizing dose (TID) up to 30 krad (Si).

The AP54RHC486 provides protection for critical applications by ensuring that on each channel only one output can be high, regardless of the signal state at the inputs. This feature is ideal for half-bridge drivers, power supplies, thrusters, and other applications where cross conduction must be avoided. This device is a member of the Apogee Semiconductor AP54RHC logic family operating across a voltage supply range of 1.65 V to 5.5 V.

Zero-power penalty™ cold-sparing is supported, along with Class 2 ESD protection on all inputs and outputs. A proprietary output stage and robust power-on reset (POR) circuit allow the AP54RHC486 to be cold-spared in any redundant configuration with no static power loss on any pad of the device. The redundant output stage also features a high drive capability with low static power loss.

The AP54RHC486 also features a triple-redundant design throughout its entire circuitry, which allows it to be immune to single-event transients (SET) without requiring additional redundant devices.

Ordering information may be found in Table 9 on Page 12.

### 1.1 FEATURES

- · 1.65 VDC to 5.5 VDC operation
- Inputs tolerant up to 5.5 VDC at any  $V_{\text{CC}}$
- Provides logic-level down translation to  $V_{\text{CC}}$
- Extended operating temperature range (-55 °C to +125 °C)
- Proprietary cold-sparing capability with zero static power penalty
- Built-in triple redundancy for enhanced reliability
- Internal power-on reset (POR) circuitry ensures reliable power up and power down responses during hot plug and cold sparing operations
- Tri-state output drivers
- Class 2 ESD protection (4000 V HBM, 500 V CDM)
- TID resilience of 30 krad (Si)
- SEL resilient up to LET of 80 MeV-cm<sup>2</sup>/mg

#### 1.2 LOGIC DIAGRAM

The AP54RHC486 logic function is shown below:

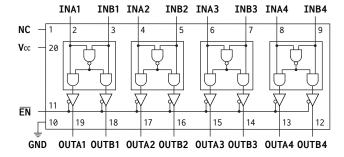


Figure 1: AP54RHC486 logic diagram

### AP54RHC486

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### 2 ACRONYMS AND ABBREVIATIONS

ESD	Electrostatic Discharge
POR	Power On Reset

RHA Radiation Hardness Assurance

SEE Single Event Effects

Single Event Latchup SEL SET Single Event Transient

Total Ionizing Dose TID

Triple Modular Redundancy TMR

Charged-Device Model CDM

HBM Human-Body Model

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### 3 LOGIC DATA

### 3.1 TRUTH TABLE

The AP54RHC486 truth table is found in Table 1. **H** indicates HIGH logic level, **L** indicates LOW logic level. **X** indicates DON'T CARE and **Z** indicates HIGH-Z (TRI-STATE). Subscript **n** reflects one of the 4 channels in the device (1 to 4).

Table 1: AP54RHC486 device truth table (per channel).

	Input		Out	put
INA <sub>n</sub>	INB <sub>n</sub>	ΕN	OUTAn	OUTB <sub>n</sub>
L	L	L	L	L
L	Н	L	L	Н
Н	L	L	Н	L
Н	Н	L	L	L
Х	Х	Н	Z	Z

### **4 PIN CONFIGURATION**

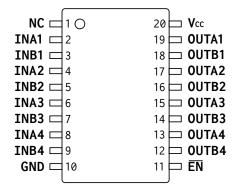


Figure 2: AP54RHC486 Device Pinout.

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### Table 2: AP54RHC486 device pinout description

PIN NAME(S)	PIN NUMBER(S)	DESCRIPTION
INA1	2	
INB1	3	
INA2	4	
INB2	5	Inputs
INA3	6	inputs
INB3	7	
INA4	8	
INB4	9	
OUTA1	19	
OUTB1	18	
OUTA2	17	
OUTB2	16	3-State Outputs
OUTA3	15	5 State Outputs
OUTB3	14	
OUTA4	13	
OUTB4	12	
EN	11	Output Enable (active-low)
V <sub>CC</sub>	20	Positive Voltage Supply
GND	10	Ground
NC	1	NO CONNECT

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### 5 ELECTRICAL CHARACTERISTICS

The sign convention for current follows JEDEC standards with negative values representing current sourced from the device and positive values representing current sunk into the device.

### 5.1 ABSOLUTE MAXIMUM RATINGS

Excursions beyond the values listed in Table 3 may cause permanent damage to the device. Proper function of the device cannot be guaranteed if these values are exceeded, and long-term device reliability may be affected. Functionality of the device at these values, or beyond those listed in Recommended Operating Conditions (Table 4) is not guaranteed.

All parameters are specified across the entire operating temperature range unless otherwise specified.

Table 3: Absolute Maximum Ratings

SYMBOL	PARAMETER		VALUE	UNITS
V <sub>cc</sub>	Supply Voltage		-0.5 to +5.5	V
VI	Input voltage range		-0.5 to +5.5	V
Vo	Output voltage range		-0.5 to V <sub>CC</sub> + 0.5 <sup>(1)</sup>	V
I <sub>IK</sub> (V <sub>I</sub> < 0)	Input clamp current		100	mA
I <sub>0</sub>	Continuous output current (per pin)		100	mA
I <sub>cc</sub>	Maximum supply current		100	mA
V <sub>ESD</sub>	ESD Voltage	НВМ	4000	V
VESD	CDM		500	V
Tj	Operating junction temperature range		-55 to +150	°C
T <sub>STG</sub>	Storage temperature range		-65 to +150	°C

 $<sup>^{(1)}</sup>$  V<sub>O</sub> must remain below absolute maximum rating of V<sub>CC</sub>

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### 5.2 RECOMMENDED OPERATING CONDITIONS

All recommended parameters below are specified across the entire operating temperature range unless otherwise specified.

Table 4: Recommended Operating Conditions

SYMBOL	PARAMETER	MIN	MAX	UNITS
V <sub>cc</sub>	Supply voltage			V
Vı	Input voltage range	0	5.5	V
Vo	Output voltage range	0	$V_{CC}$	V
	V <sub>CC</sub> = 1.65 to 1.95 V	1.4	-	
V <sub>IH</sub>	HIGH-level input voltage $V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$	1.9	-	V
	$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$	2.5	-	, v
	$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$	3.8	-	
	$V_{CC}$ = 1.65 to 1.95 V	-	0.4	
V <sub>IL</sub>	LOW-level input voltage $V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$	-	0.6	V
VIL	$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$	-	0.9	•
	$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$	-	1.35	
	$V_{CC}$ = 1.65 to 1.95 V	-	-4	mA
I <sub>OH</sub>	HIGH-level output current $V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$	-	-8	
чОН	$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$	-	-16	
	$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$	-	-24	
	$V_{CC}$ = 1.65 to 1.95 V	-	4	
I <sub>OL</sub>	LOW-level output current $V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$	-	8	mA
'OL	$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$	-	16	1117
	$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$	-	24	
	V <sub>CC</sub> = 1.65 to 1.95 V	-	1000	
t. t.	Input rise or fall time $V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$	-	600	ns
t <sub>r</sub> , t <sub>f</sub>	(10% - 90%) $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$	-	500	113
	$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$	-	400	

Table 5: Thermal Information

SYMBOL	PARAMETER		TYP	MAX	UNITS
Tj	Operating junction temperature	-55	-	+125	°C
$R_{\theta JA}$	Junction to ambient thermal resistance	-	100	=	°C/W

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### **5.3 STATIC CHARACTERISTICS**

All parameters are specified across the entire operating temperature range unless otherwise specified.

**Table 6:** DC Electrical Characteristics

SYMBOL	PARAMETER	CONDITIONS	V <sub>cc</sub>	MIN	TYP	MAX	UNITS
		Ι <sub>Ο</sub> = 100 μΑ	1.65 to 5.5 V	-	0.02	0.05	V
		I <sub>O</sub> = 1 mA	1.65 to 5.5 V	-	0.05	0.15	V
			2.3 V	-	0.3	0.6	V
		I <sub>O</sub> = 4 mA	3.0 V	-	0.2	0.4	V
			4.5 V	-	0.2	0.4	V
V <sub>OL</sub>	LOW-level		2.3 V	-	0.6	1.0	V
		$I_0 = 8 \text{ mA}$	3.0 V	-	0.4	0.8	V
	output voltage		4.5 V	-	0.3	0.6	V
		I <sub>O</sub> = 16 mA	3.0 V	-	1.0	1.4	V
		10 - 10 IIIA	4.5 V	-	1.1	1.2	V
		I <sub>O</sub> = 24 mA	4.5 V	-	1.1	1.5	V
		I <sub>O</sub> = -100 μA	1.65 to 5.5 V	V <sub>CC</sub> - 0.1	V <sub>CC</sub> - 0.02	-	V
		I <sub>O</sub> = -1 mA	1.65 to 5.5 V	V <sub>CC</sub> - 0.15	V <sub>CC</sub> - 0.08	-	V
		I <sub>O</sub> = -4 mA	2.3 V	1.8	2.0	-	V
			3.0 V	2.6	2.8	=	V
			4.5 V	4.2	4.4	-	V
	HIGH-level	I <sub>O</sub> = -8 mA	2.3 V	1.4	1.7	-	V
$V_{OH}$			3.0 V	2.2	2.5	=	V
	output voltage		4.5 V	3.9	4.1	=	V
		I <sub>O</sub> = -16 mA	3.0 V	1.5	2.0	-	V
		10 - 10 IIIA	4.5 V	3.3	3.8	-	V
		I <sub>O</sub> = -24 mA	4.5 V	3.0	3.5	-	V
I <sub>cc</sub>	Supply current (quiescent)	$V_I = GND$ $I_O = 0 mA$	5.5 V	-	130	TBD	μΑ
II	Input current	$V_I = V_{CC}$ or GND	1.65 to 5.5 V	-	±1	±5	μΑ
l <sub>OZ</sub>	Output leakage current	$V_1 = V_{CC}$ or GND $\overline{EN} = "1"$	1.65 to 5.5 V	-	<b>±</b> TBD	±5	μΑ
I <sub>OFF</sub>	Powerdown leakage current	V <sub>I</sub> = V <sub>CC</sub> or GND	'Z' or GND	-	<b>±</b> TBD	<b>±</b> TBD	nA

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### 5.4 DYNAMIC CHARACTERISTICS

All parameters are specified across the entire operating temperature range unless otherwise specified. Subscript **n** reflects one of the 4 channels in the device (1 to 4).

**Table 7:** AC Electrical Characteristics

SYMBOL	PARAMETER	CONDITIONS	V <sub>cc</sub>	MIN	TYP	MAX	UNITS
	Propagation Delay		4.5 to 5.5 V	-	10	15	ns
<b>t</b> <sub>pd</sub> <sup>(1)</sup>	(Input <b>A<sub>n</sub>,B<sub>n</sub></b>	C <sub>L</sub> = 50 pF	3.0 to 3.6 V	-	13	21	ns
Lpd T	to Output <b>OUTA<sub>n</sub>,OUTB<sub>n</sub></b> )	С[ - 30 рі	2.3 to 2.7 V	-	16	28	ns
	to Output <b>OutA<sub>n</sub>,OutB<sub>n</sub>)</b>		1.65 to 1.95 V	-	25	45	ns
	Output Enable Time		4.5 to 5.5 V	-	15	25	ns
t <sub>en</sub> (2)	(Input <b>EN</b>	C <sub>L</sub> = 50 pF	3.0 to 3.6 V	-	22	35	ns
L'en`	to Output <b>OUTA<sub>n</sub>,OUTB<sub>n</sub></b> )		2.3 to 2.7 V	-	29	41	ns
	to Output <b>OutA<sub>n</sub>,OutB<sub>n</sub></b> )		1.65 to 1.95 V	-	43	53	ns
	Output Disable Time (Input <b>EN</b> to Output <b>OUTA<sub>n</sub>,OUTB</b> <sub>n</sub> )	$C_L = 50 \text{ pF}$ 3.0 2.3 1.65	4.5 to 5.5 V	-	16	25	ns
<b>t</b> dis (3)			3.0 to 3.6 V	-	22	35	ns
Ldis			2.3 to 2.7 V	-	28	40	ns
	to Output <b>OUTA<sub>n</sub>,OUTB<sub>n</sub>)</b>		1.65 to 1.95 V	-	42	51	ns
t <sub>sk</sub>	Channel-to-channel skew	C <sub>L</sub> = 50 pF	1.65 to 5.5 V	-	-	TBD	ns
			4.5 to 5.5 V	TBD	TBD	TBD	ns
	Minimum Non-Overlap	C <sub>L</sub> = 50 pF	3.0 to 3.6 V	TBD	TBD	TBD	ns
t <sub>min-nol</sub>	(Input <b>A</b> or <b>B</b> )	CL - 30 pi	2.3 to 2.7 V	TBD	TBD	TBD	ns
			1.65 to 1.95 V	TBD	TBD	TBD	ns
C <sub>IN</sub>	Input Capacitance <sup>(4)</sup>	$V_I = V_{CC}$ or GND	1.65 to 5.5 V	-	2	4	pF
C <sub>PD</sub>	Power dissipation capacitance <sup>(4)</sup>	I <sub>O</sub> = 0 mA, f = 1 MHz	5.5 V	-	40	-	pF

<sup>(1)</sup> equivalent to t<sub>PLH</sub>, t<sub>PHL</sub>

### 5.5 RADIATION RESILIENCE

For detailed radiation testing reports, please contact Apogee Semiconductor at sales@apogeesemi.com.

Table 8: Radiation Resilience Characteristics

PARAMETER	CONDITIONS	VALUE	UNITS
Total Ionizing Dose (TID)	Please contact Apogee Semiconductor for test report.	30	krad (Si)
SEE LET Threshold	Please contact Apogee Semiconductor for test report.	<80	MeV-cm <sup>2</sup> /mg

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 $<sup>^{(2)}</sup>$  equivalent to  $t_{PZL}$ ,  $t_{PZH}$ 

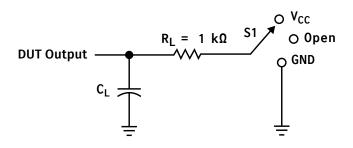
 $<sup>^{(3)}</sup>$  equivalent to  $t_{PLZ}$ ,  $t_{PHZ}$ 

<sup>(4)</sup> guaranteed by design

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### 5.6 CHARACTERISTICS MEASUREMENT INFORMATION



 $\begin{tabular}{ll} \textbf{TEST} & \textbf{S1} \\ \hline $t_{pd}$ & Open \\ \hline $t_{PLZ}, t_{PZL}$ & $V_{CC}$ \\ \hline $t_{PHZ}, t_{PZH}$ & GND \\ \hline \end{tabular}$ 

Figure 3: Load circuit for 3-state outputs

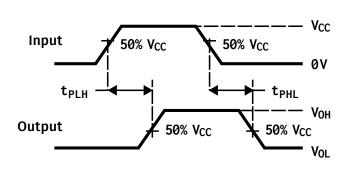
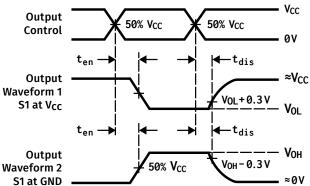


Figure 4: Propagation delay measurement



**Figure 5:** Enable and disable times, for low- and high-level enables

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### 6 DETAILED DESCRIPTION

The AP54RHC486 is a Quad-Channel Dual-Input Arbiter designed to operate from a wide supply voltage of 1.65 to 5.5 V with fully redundant input and output stages, providing for superior radiation resilience.

The output and input stages are constructed with transient activated clamps (Figure 6, 7) that prevent inadvertent biasing of the V<sub>CC</sub> power rail through parasitic diodes inherent to conventional input, output, and ESD circuits. The IC also incorporates an internal power-on reset (POR) circuit that prevents the output from driving erroneous results during power-on, and guarantees correct operation at power supply voltages as low as 1.65 V. While the supply is ramping, the POR holds the output buffer in tri-state, a feature that prevents unwanted DC current during cold sparing on input and output pins.

The AP54RHC family's I/O protection circuitry allows for cold sparing configurations as it avoids a leakage current penalty on inputs and outputs while in a power-down state. This can result in considerable power savings in systems where multiple-path redundancy is employed. The ESD clamp circuits for this logic family are designed to support Class 2 ESD levels of 4 kV HBM and 500 V CDM.

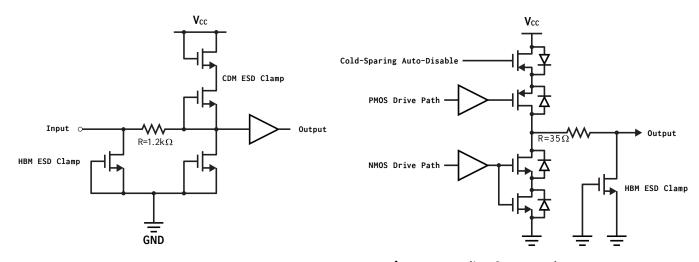


Figure 6: Details of input pin structure

Figure 7: Details of output pin structure

#### Note

During tri-state, the application must ensure that the output pins are either held or switched to logic high or logic low levels i.e. close to  $V_{cc}$  or **GND**, otherwise increased supply current can occur.

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## **Rad-Hard Quad Channel Dual Input Arbiter**

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### 7 APPLICATIONS INFORMATION

### 7.1 USE IN COLD-SPARING CONFIGURATION

As the AP54RHC family is radiation-hardened by design and includes internal TMR, it can be utilized in high-reliablity applications without additional supporting circuitry or devices. Nonetheless, some application requirements call for fully-redundant designs, where an "A" and a "B" device are required, often on separate power rails.

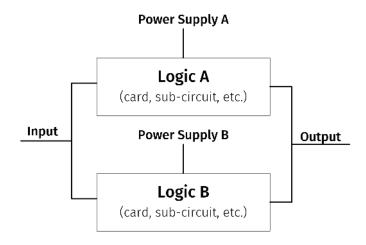


Figure 8: Two-path cold-sparing configuration.

With the cold-sparing capability of the AP54RHC family, fully redundant "A" and "B" functions may be placed in parallel (as seen in Figure 8) running off redundant power supplies. The inputs and outputs on each one of these functions are assumed to be based on the AP54RHC family, allowing for direct parallel connection without unwanted leakage current paths during cold sparing. In the event of a failure in power supply A or within function A, the system can simply shut power supply A off and switch on power supply B, without requiring additional input or output switching or configuration changes.

### 7.2 POWER SUPPLY RECOMMENDATIONS

This device can operate at any voltage within the range specified in Table 4 Recommended Operating Conditions.

At a minimum, a 16 VDC (or higher), X7R-rated 0.1  $\mu$ F ceramic decoupling capacitor should be placed near (within 1 cm) the  $V_{CC}$  pin of the device.

### 7.3 APPLICATION TIPS

Unused **inputs** must **not** be left floating. They may be connected to either a low (GND) or high (V<sub>CC</sub>) bias to provide a known state at the input of the device. Resistors may be used to tie off unused inputs. In the event of a design change, such resistors can be removed, thereby allowing use of the inputs without having to cut traces on the PCB.

Any **NC** pin(s) can be left floating or may be connected to either a low (GND) or high ( $V_{CC}$ ) bias.

An unused **output** may be left floating. It is suggested that it be routed to a test point or similar accessible structure in case the gate needs to be utilized as part of a design revision.

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### **8 ORDERING INFORMATION**

Example part numbers for the AP54RHC486 are listed in Table 9. The full list of options for this part can be found in Figure 9. Please contact Apogee Semiconductor sales at sales@apogeesemi.com for further information on sampling, lead time and purchasing on specific part numbers.

Table 9: AP54RHC486 Ordering Information

DEVICE	DESCRIPTION	PACKAGE
AP54RHC486ELT-W	Radiation Hardened Quad-Channel Dual-Input Arbiter (for evaluation only)	Plastic TSSOP-20
AP54RHC486ALT-R	Radiation Hardened Quad-Channel Dual-Input Arbiter (30 krad (Si))	Plastic TSSOP-20

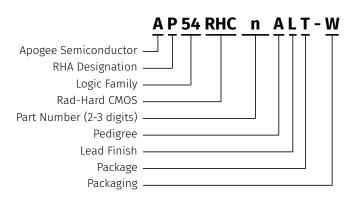


Figure 9: Part Number Decoder

- 1. RHA Designation
  - **P** 30 krad (Si)
- 2. Part Number
  - \_ 486 (Quad-Channel Dual-Input Arbiter)
- 3. Pedigree
  - **A** -55 to +125 °C (Burn-in)
  - **B** -55 to +125 °C (No burn-in)
  - **E** 25 °C Functional Test Only (Evaluation)
- 4. Lead Finish
  - L Tin-Lead (SnPb)
- 5. Package
  - **T** 20-pin Thin Shrink Small Outline Package (TSSOP)
- 6. Packaging
  - **W** Waffle Pack or Pillow Stat Box
  - **R** Tape and Reel<sup>(1)</sup>

### 9 REVISION HISTORY

REVISION	DESCRIPTION	DATE
A00	Initial Release.	2023-04-19

For the latest version of this document, please visit https://www.apogeesemi.com.

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<sup>(1)</sup> Contact us for custom reel quantities. Orders less than full reel quantities may be shipped as cut tape.

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### 10 LEGAL

All product, product specifications and data are subject to change without notice.

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